

High and Low Side Driver

Features

- Floating channel designed for bootstrap operation
- Fully operational to 200V
- Tolerant to negative transient voltage, dV/dt immune
- Gate drive supply range from 10 to 20V
- Independent low and high side channels
- Input logic HIN/LIN active high
- Undervoltage lockout for both channels
- 3.3V and 5V logic compatible
- CMOS Schmitt-triggered inputs with pull-down
- Matched propagation delay for both channels

Description

The IRS2011 is a high power, high speed power MOSFET driver with independent high and low side referenced output channels. Logic inputs are compatible with standard CMOS or LSTTL output, down to 3.3V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. Propagation delays are matched to simplify use in high frequency applications. The floating channel can be used to drive an N-channel power MOSFET in the high side configuration which operates up to 200 volts. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction.

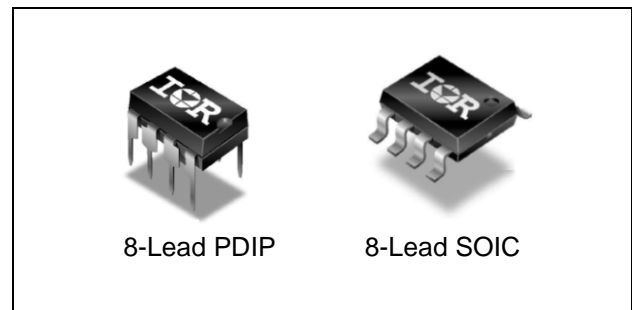
Applications

- Converters
- DC motor drive

Product Summary

V_{OFFSET} (max)	200V
$I_{\text{O+/-}}$ (typ)	1.0A / 1.0A
V_{OUT}	10 – 20V
$t_{\text{on/off}}$ (typ)	60ns
Delay Matching (max)	20ns

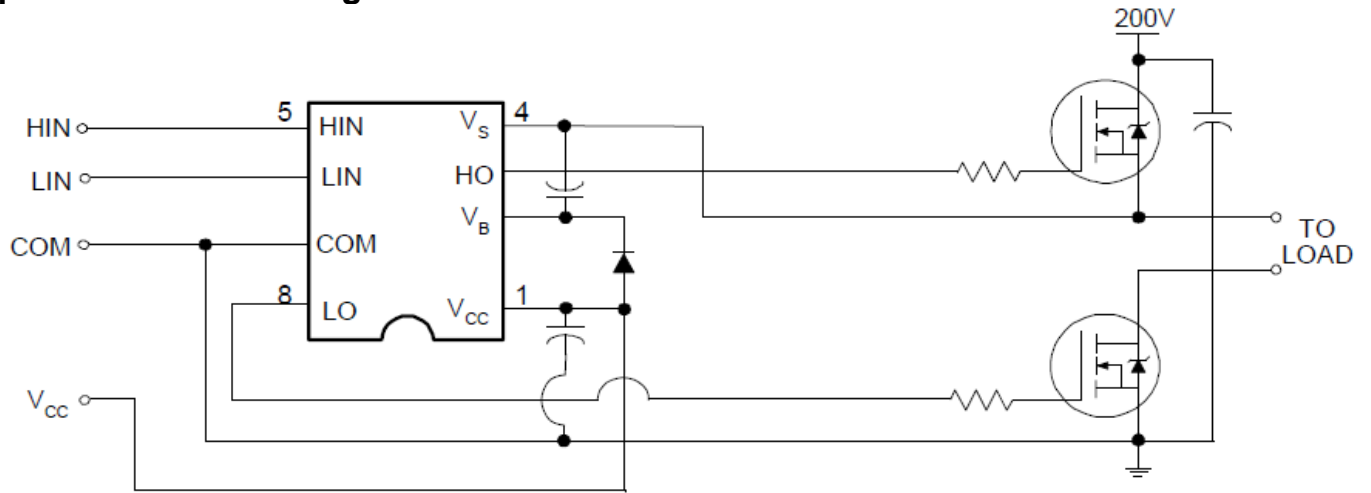
Package Options



Ordering Information

Base Part Number	Package Type	Standard Pack		Orderable Part Number
		Form	Quantity	
IRS2011PBF	PDIP8	Tube	50	IRS2011PBF
IRS2011SPBF	SO8N	Tube	95	IRS2011SPBF
IRS2011SPBF	SO8N	Tape and Reel	2500	IRS2011STRPBF

Typical Connection Diagram



(Refer to Lead Assignments for correct configuration.) This diagram shows electrical connections only. Please refer to our Application Notes and Design Tips for proper circuit board layout.

Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units	
V_B	High side floating supply voltage	-0.3	220 [†]	V	
V_S	High side floating supply offset voltage	$V_B - 20$	$V_B + 0.3$		
V_{HO}	High side floating output voltage	$V_S - 0.3$	$V_B + 0.3$		
V_{CC}	Low side fixed supply voltage	-0.3	20 [†]		
V_{LO}	Low side output voltage	-0.3	$V_{CC} + 0.3$		
V_{IN}	Logic input voltage (HIN, LIN)	-0.3	$V_{CC} + 0.3$		
dV_S/dt	Allowable offset supply voltage transient	—	50	V/ns	
P_D	Package power dissipation @ $T_A \leq +25^\circ\text{C}$	8-Lead PDIP	—	1.0	W
		8-Lead SOIC	—	0.625	
R_{thJA}	Thermal resistance, junction to ambient	8-Lead PDIP	—	125	$^\circ\text{C/W}$
		8-Lead SOIC	—	200	
T_J	Junction temperature	—	150	$^\circ\text{C}$	
T_S	Storage temperature	-55	150		
T_L	Lead temperature (soldering, 10 seconds)	—	300		

† All supplies are fully tested at 25V and an internal 20V clamp exists for each supply

Recommended Operating Conditions

For proper operation the device should be used within the recommended conditions. The V_S and COM offset ratings are tested with all supplies biased at 15V differential.

Symbol	Definition	Min.	Max.	Units
V_B	High side floating supply absolute voltage	$V_S + 10$	$V_S + 20$	V
V_S	High side floating supply offset voltage	††	200	
V_{HO}	High side floating output voltage	V_S	V_B	
V_{CC}	Low side fixed supply voltage	10	20	
V_{LO}	Low side output voltage	0	V_{CC}	
V_{IN}	Logic input voltage (HIN, LIN)	COM	V_{CC}	
T_A	Ambient temperature	-40	125	$^\circ\text{C}$

†† Logic operational for V_S of -5 to +200V. Logic state held for V_S of -5V to $-V_{BS}$.

Dynamic Electrical Characteristics

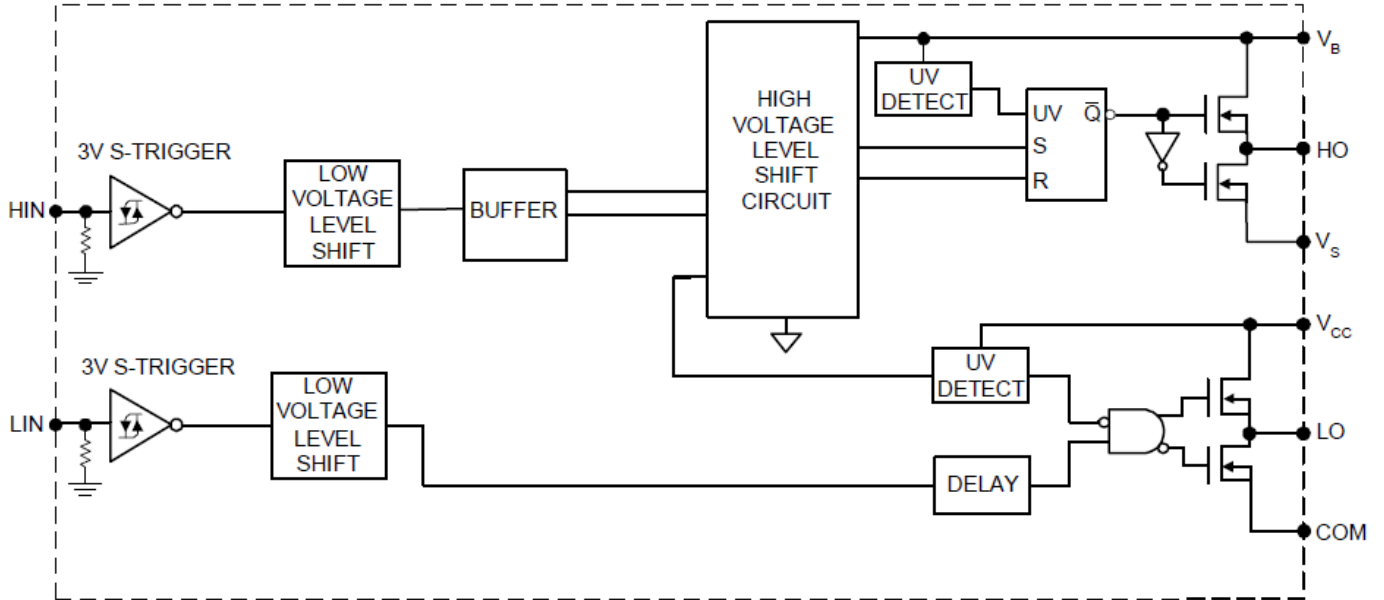
V_{BIAS} (V_{CC} , V_{BS}) = 15V, C_L = 1000pF and T_A = 25°C unless otherwise specified. Figure 1 shows the timing definitions.

Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions
t_{on}	Turn-on propagation delay	—	60	80	ns	$V_S = 0V$
t_{off}	Turn-off propagation delay	—	60	80		$V_S = 200V$
t_r	Turn-on rise time	—	25	40		DM1 $t_{on}(H) - t_{on}(L)$
t_f	Turn-off fall time	—	15	35		
DM1	Turn-on delay matching	—	—	20		
DM2	Turn-off delay matching	—	—	20		

Static Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS}) = 15V and T_A = 25°C unless otherwise specified. The V_{IN} , V_{TH} and I_{IN} parameters are referenced to COM and are applicable to all logic input leads: HIN and LIN. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

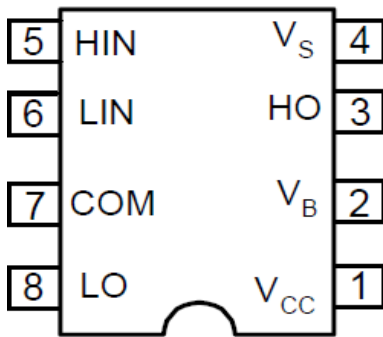
Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions	
V_{IH}	Logic "1" input voltage	2.5	—	—	V	$V_{CC} = 10V - 20V$	
V_{IL}	Logic "0" input voltage	—	—	0.7			
V_{OH}	High level output voltage, $V_{BIAS} - V_O$	—	—	1.4			$I_O = 0A$
V_{OL}	Low level output voltage, V_O	—	—	0.1			$I_O = 20mA$
I_{LK}	Offset supply leakage current	—	—	50	μA	$V_B = V_S = 200V$	
I_{QBS}	Quiescent V_{BS} supply current	—	120	210		$V_{IN} = 0V$ or 3.3V	
I_{QCC}	Quiescent V_{CC} supply current	—	200	300			
I_{IN+}	Logic "1" input bias current	—	3	10			$V_{IN} = 3.3V$
I_{IN-}	Logic "0" input bias current	—	—	5		$V_{IN} = 0V$	
V_{BSUV+}	V_{BS} supply undervoltage positive going threshold	8.3	9.0	9.7	V		
V_{BSUV-}	V_{BS} supply undervoltage negative going threshold	7.5	8.2	8.9			
V_{CCUV+}	V_{CC} supply undervoltage positive going threshold	8.3	9.0	9.7			
V_{CCUV-}	V_{CC} supply undervoltage negative going threshold	7.5	8.2	8.9			
I_{O+}	Output high short circuit pulsed current	—	1.0	—	A	$V_O = 0V$, $PW \leq 10 \mu s$	
I_{O-}	Output low short circuit pulsed current	—	1.0	—		$V_O = 15V$ $PW \leq 10 \mu s$	

Functional Block Diagram


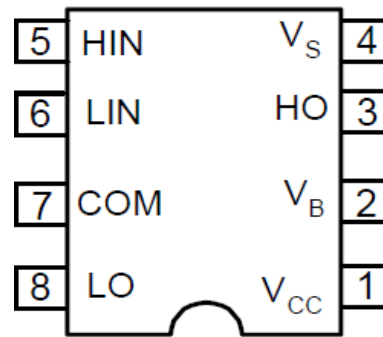
Lead Definitions

Symbol	Description
HIN	Logic input for high side gate driver outputs (HO), in phase
LIN	Logic input for low side gate driver outputs (LO), in phase
V _B	High side floating supply
HO	High side gate drive output
V _S	High side floating supply return
V _{CC}	Low side supply
LO	Low side gate drive output
COM	Low side return

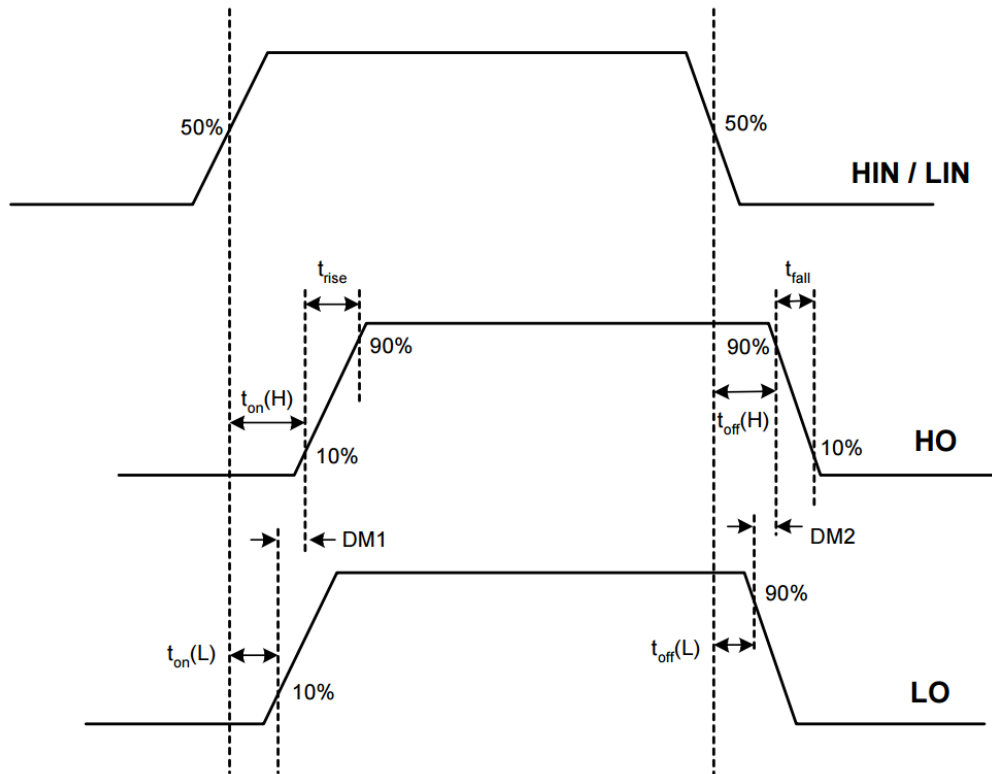
Lead Assignments



8-Lead PDIP



8-Lead SOIC

Application Information and Additional Details

Figure 1. Timing Diagram

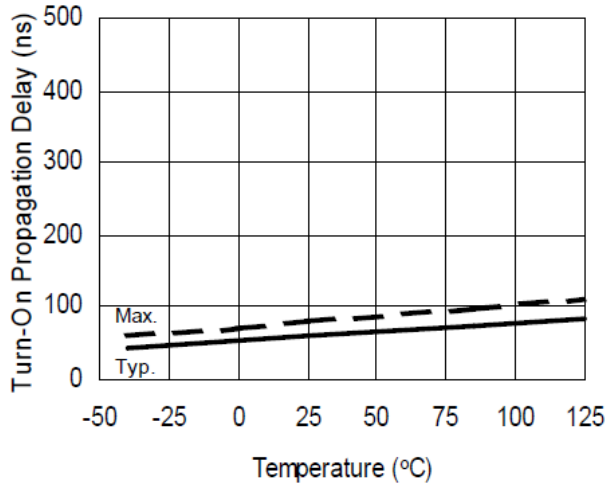


Figure 2A. Turn-on Propagation Delay vs. Temperature

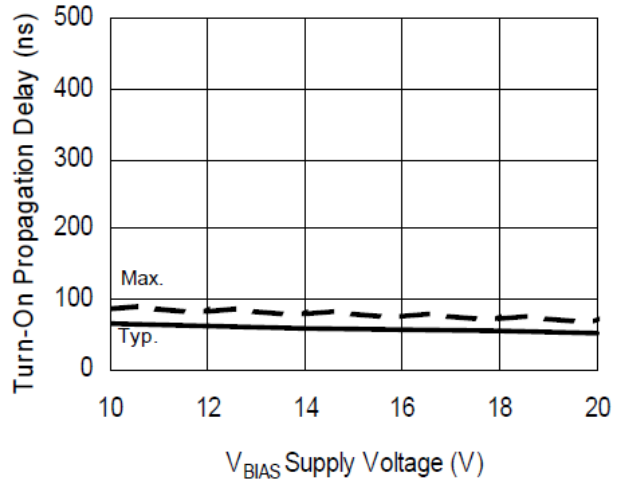


Figure 2B. Turn-on Propagation Delay vs. Supply Voltage

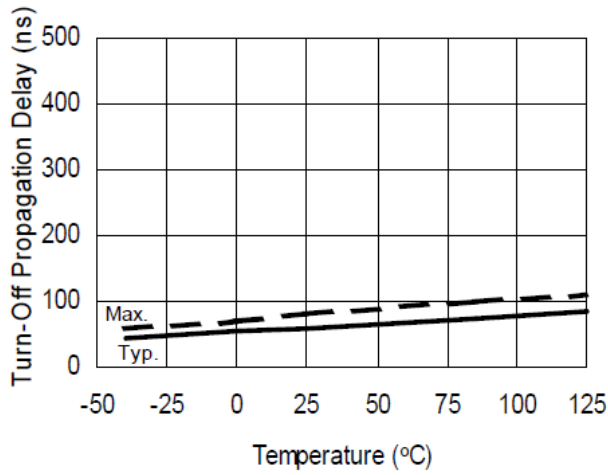


Figure 3A. Turn-off Propagation Delay vs. Temperature

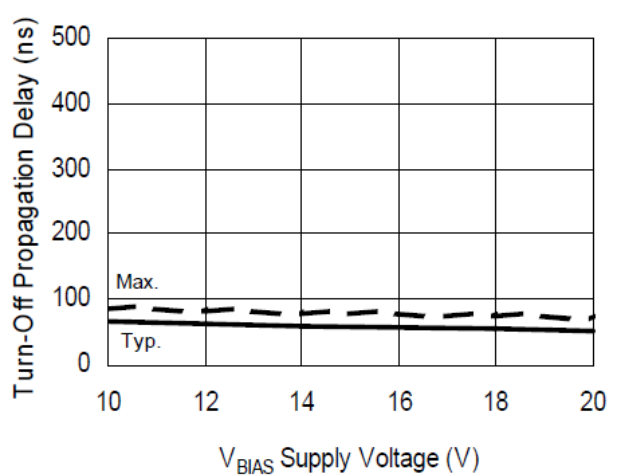
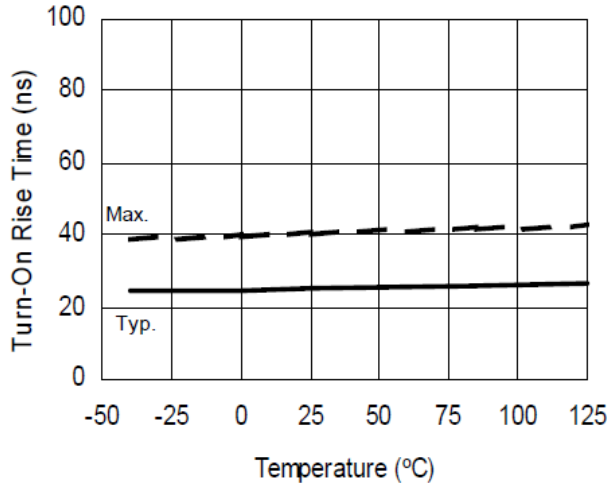
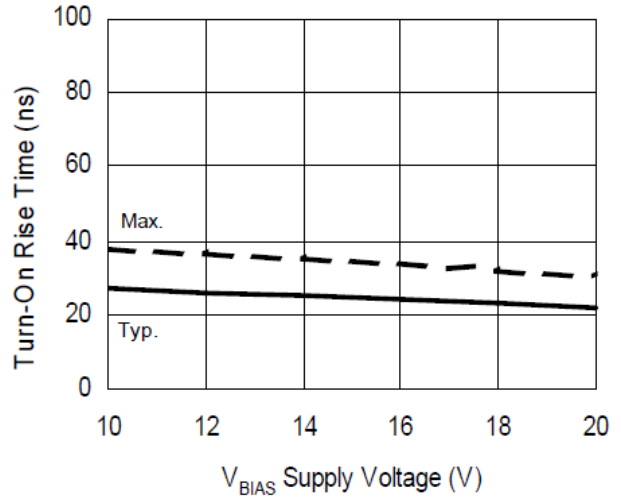
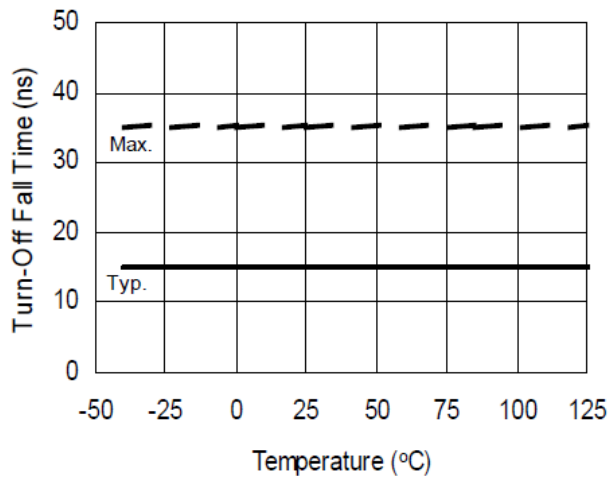
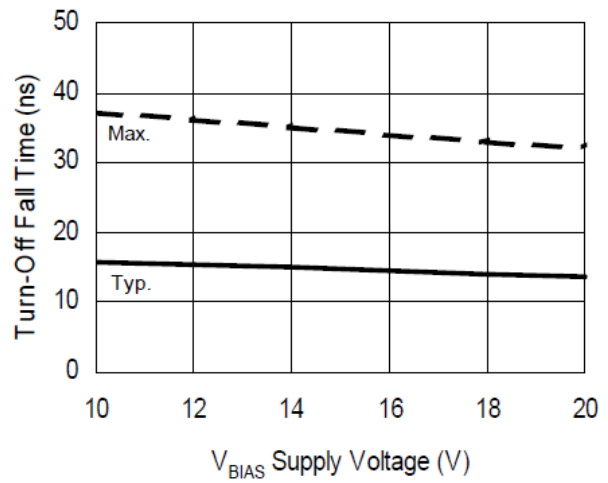


Figure 3B. Turn-off Propagation Delay vs. Supply Voltage


Figure 4A. Turn-on Rise Time vs. Temperature

Figure 4B. Turn-on Rise Time vs. Supply Voltage

Figure 5A. Turn-off Fall Time vs. Temperature

Figure 5B. Turn-off Fall Time vs. Supply Voltage

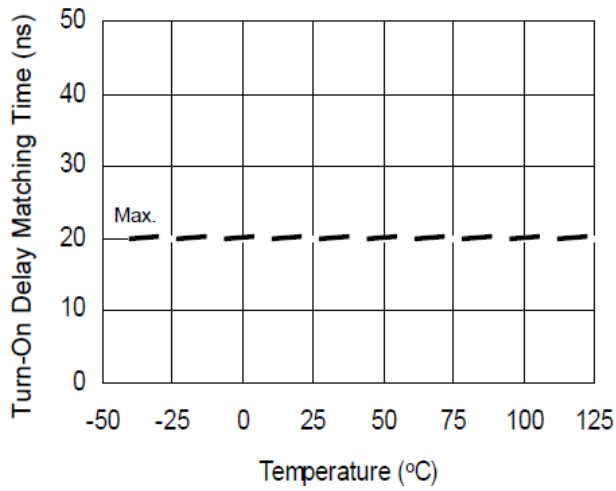


Figure 6A. Turn-on Delay Matching Time vs. Temperature

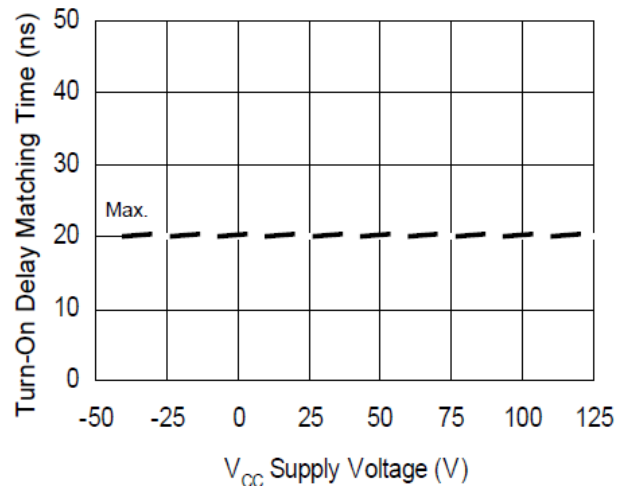


Figure 6B. Turn-on Delay Matching Time vs. Supply Voltage

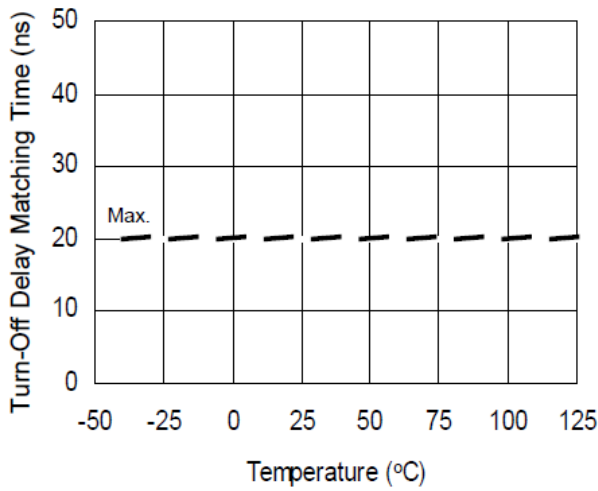


Figure 7A Turn-off Delay Matching Time vs. Temperature

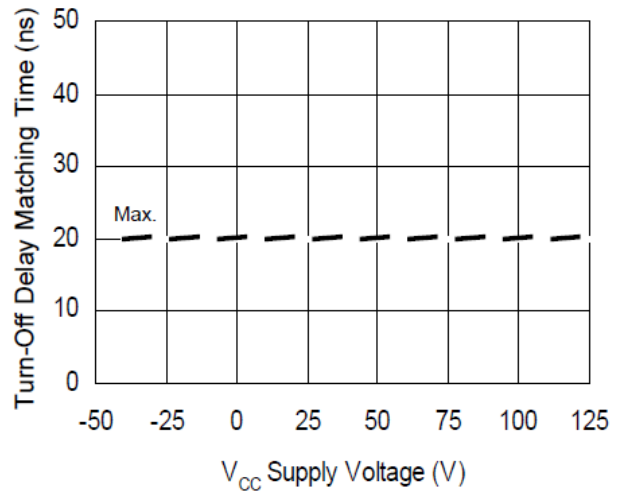
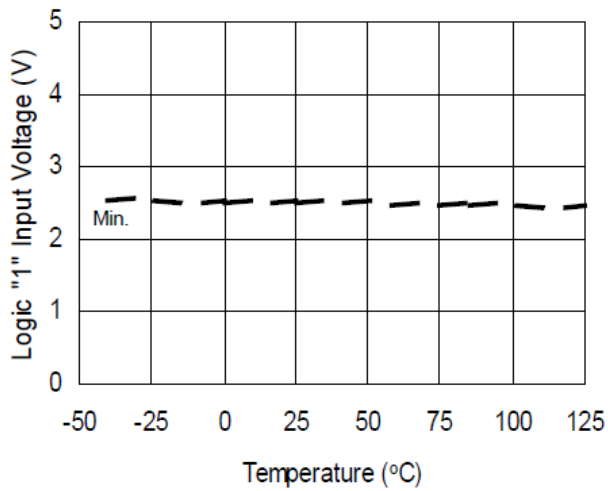
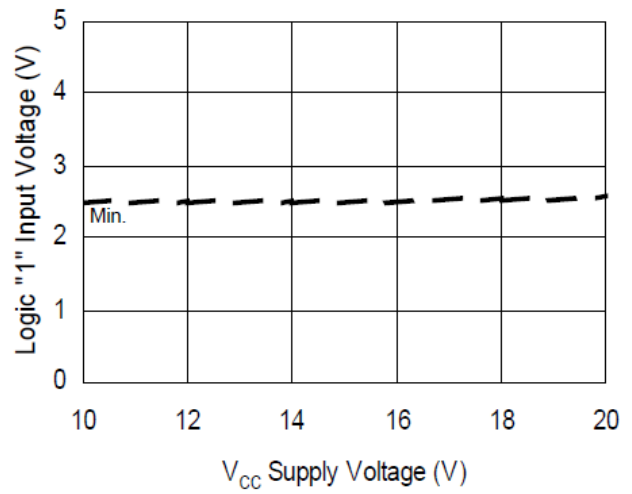
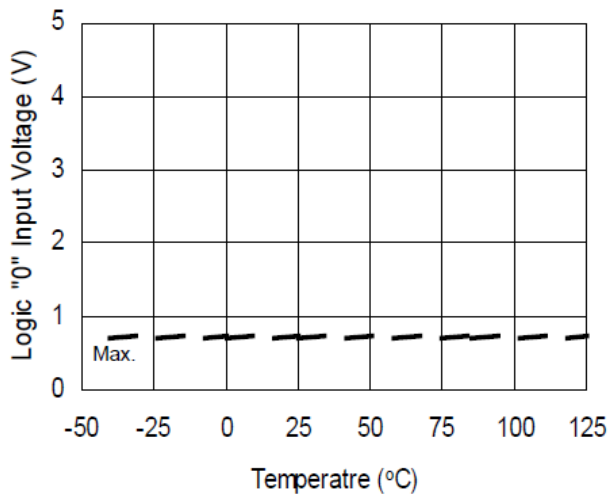
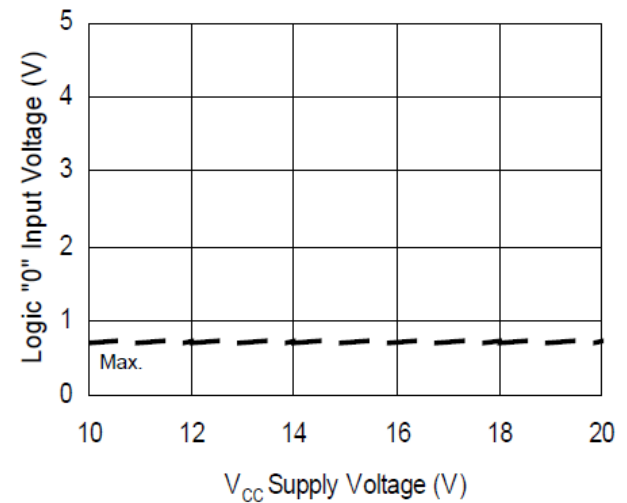


Figure 7B. Turn-off Delay Matching Time vs. Supply Voltage


Figure 8A. Logic "1" Input Voltage vs. Temperature

Figure 8B. Logic "1" Input Voltage vs. Supply Voltage

Figure 9A. Logic "0" Input Voltage vs. Temperature

Figure 9B. Logic "0" Input Voltage vs. Supply Voltage

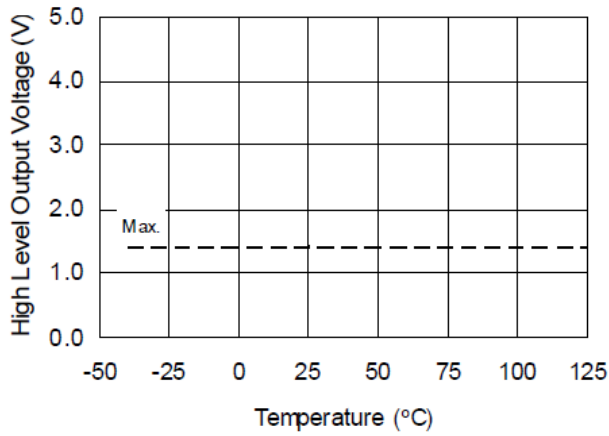


Figure 10A. High Level Output Voltage vs. Temperature ($I_o = 0\text{mA}$)

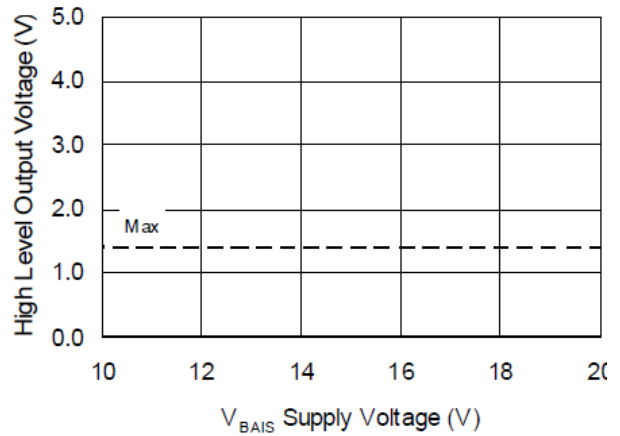


Figure 10B. High Level Output Voltage vs. Supply Voltage ($I_o = 0\text{mA}$)

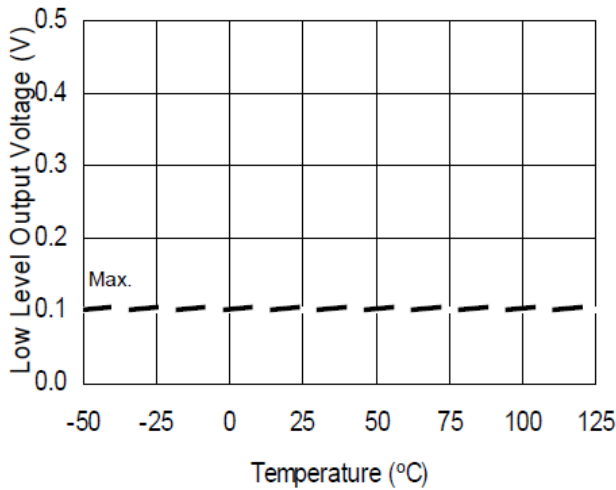


Figure 11A. Low Level Output Voltage vs. Temperature

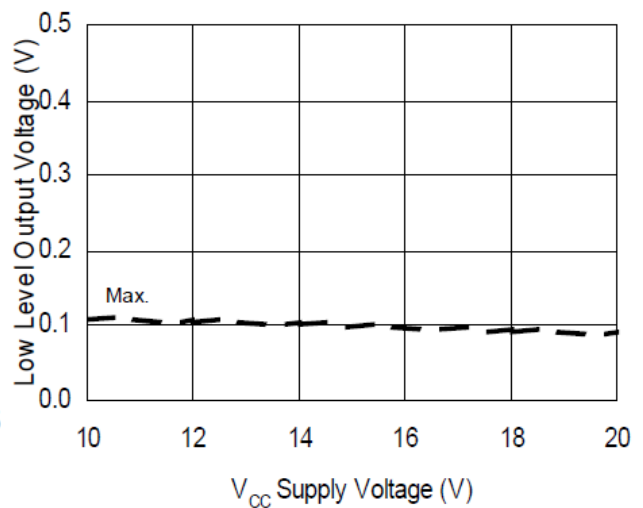


Figure 11B. Low Level Output vs. Supply Voltage

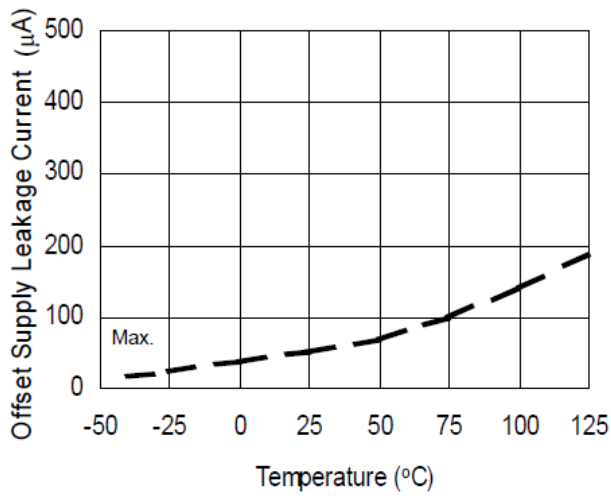


Figure 12A. Offset Supply Leakage Current vs. Temperature

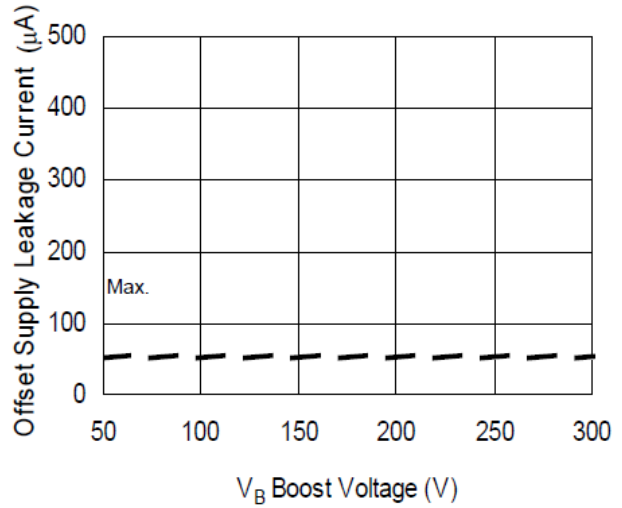


Figure 12B. Offset Supply Leakage Current vs. Supply Voltage

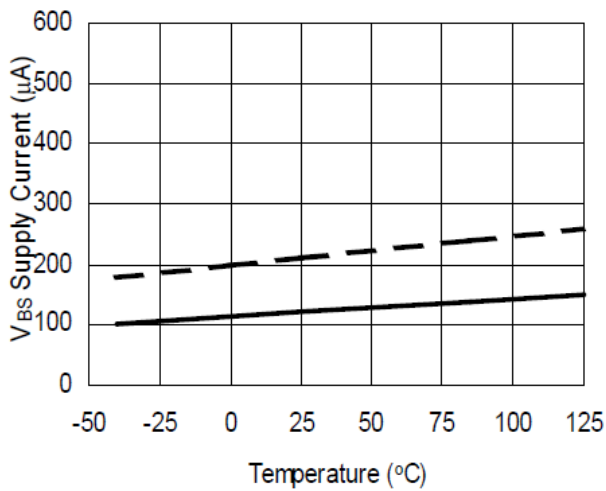


Figure 13A. V_{BS} Supply Current vs. Temperature

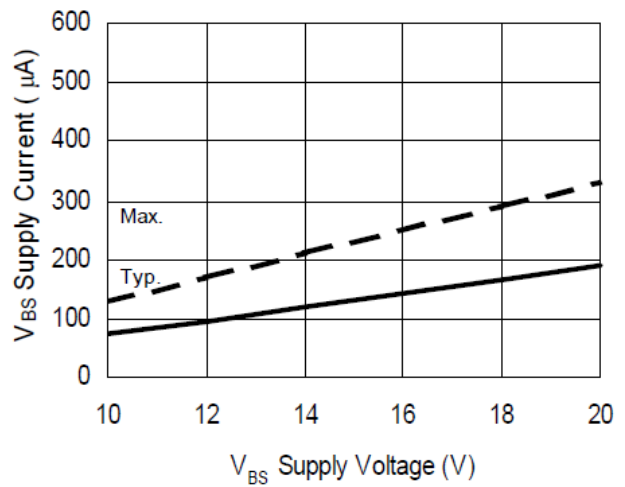
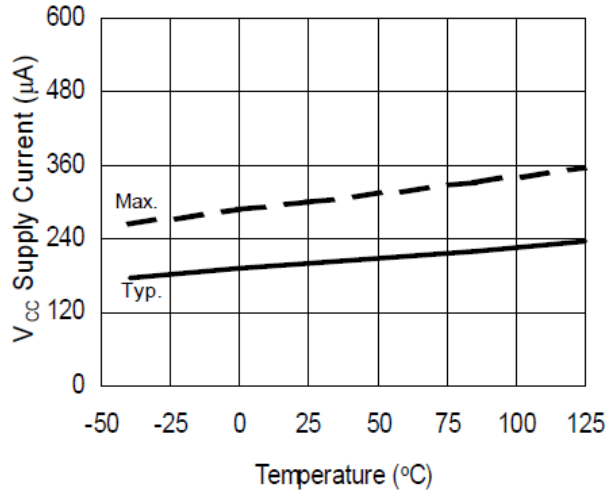
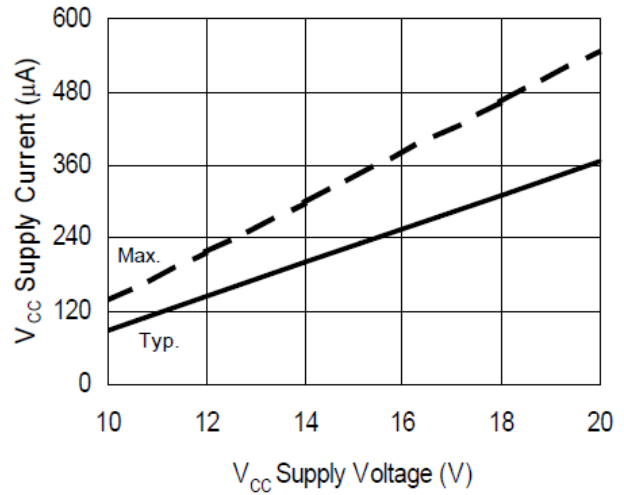
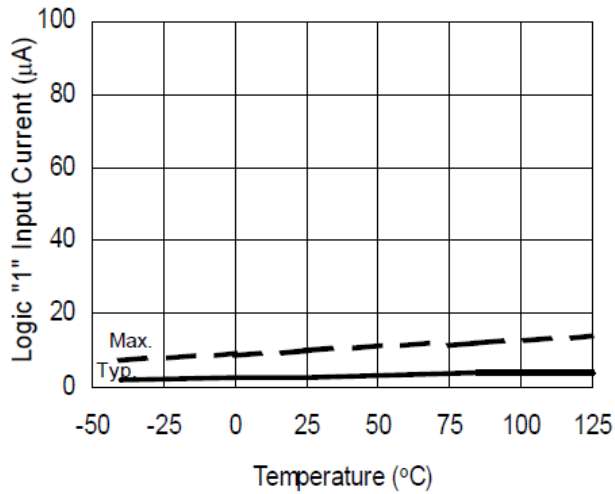
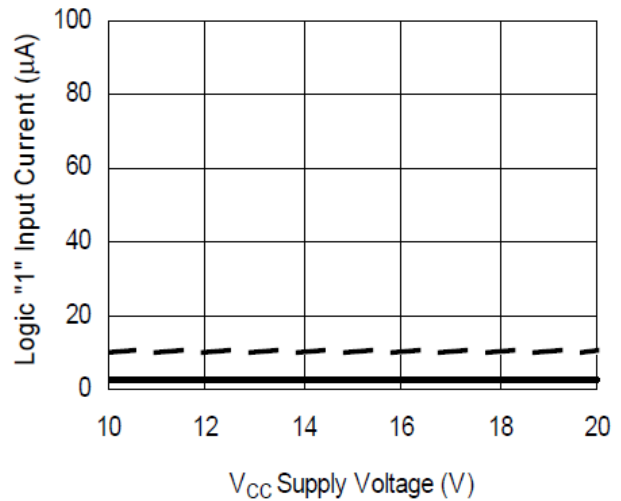


Figure 13B. V_{BS} Supply Current vs. Supply Voltage


Figure 14A. V_{CC} Supply Current vs. Temperature

Figure 14B. V_{CC} Supply Current vs. Supply Voltage

Figure 15A. Logic "1" Input Current vs. Temperature

Figure 15 B. Logic "1" Input Current vs. Supply Voltage

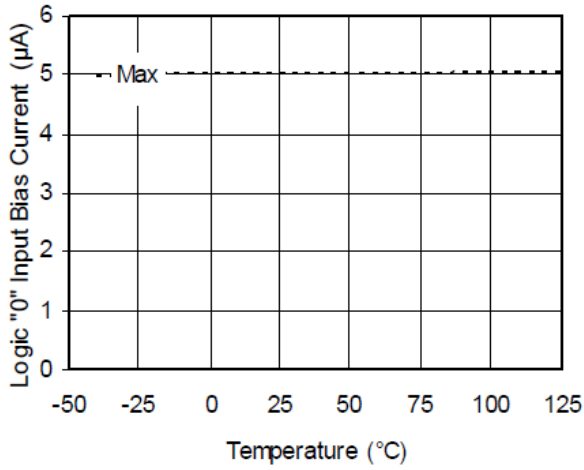


Figure 16A. Logic "0" Input Bias Current vs. Temperature

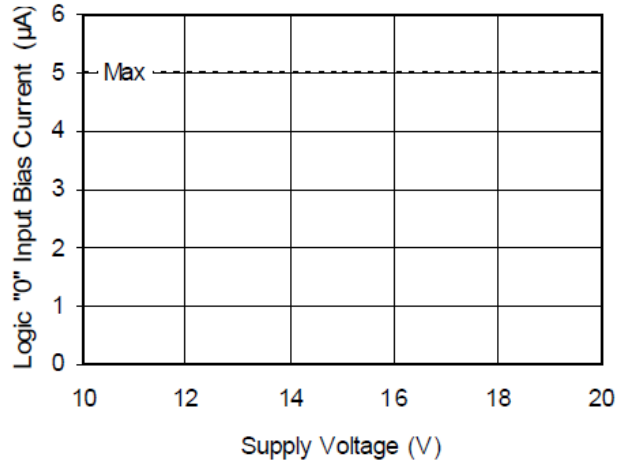


Figure 16B. Logic "0" Input Bias Current vs. Voltage

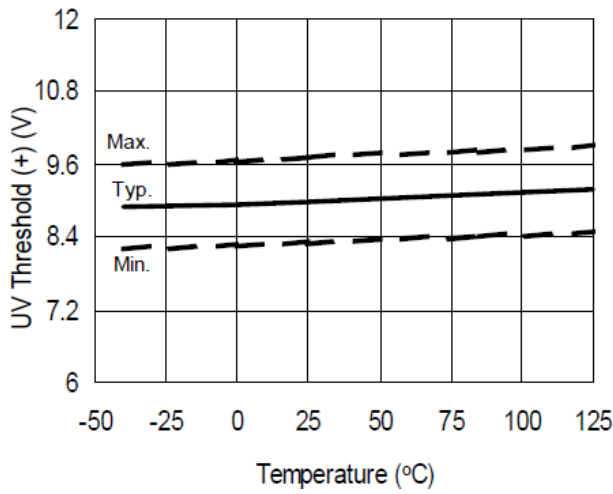


Figure 17. V_{CC} and V_{BS} Undervoltage Threshold (+) vs. Temperature

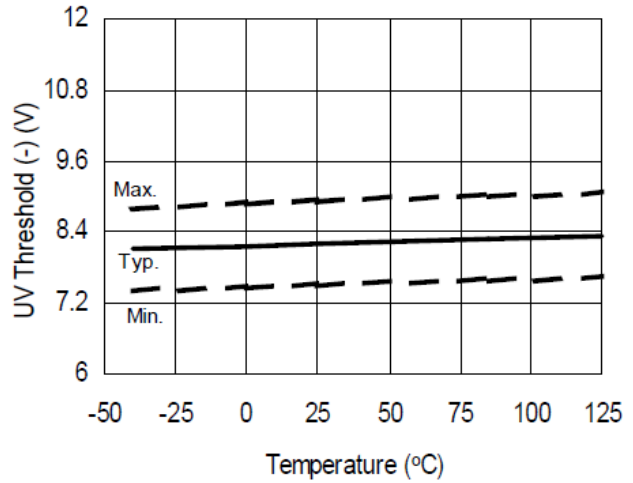
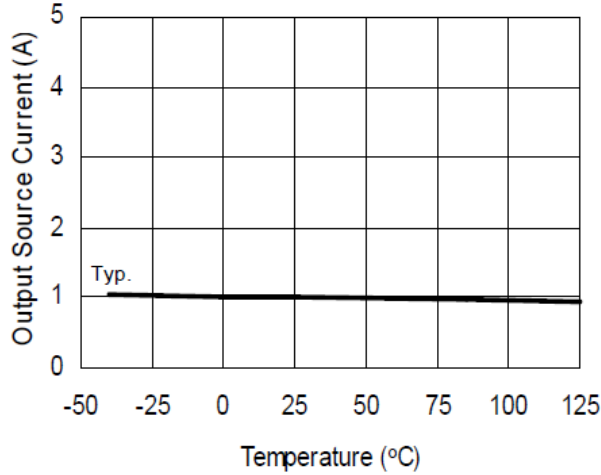
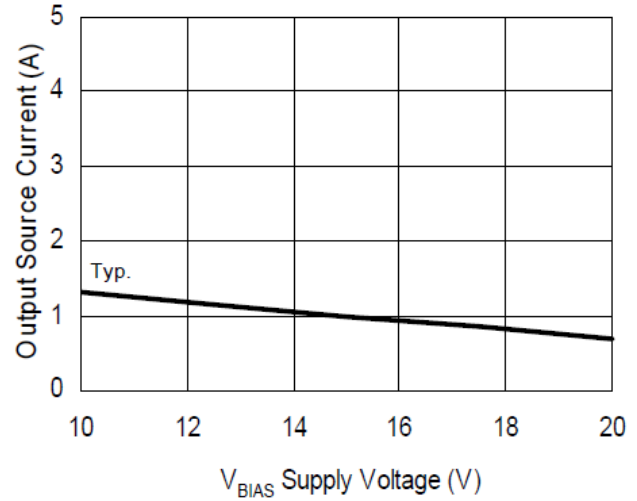
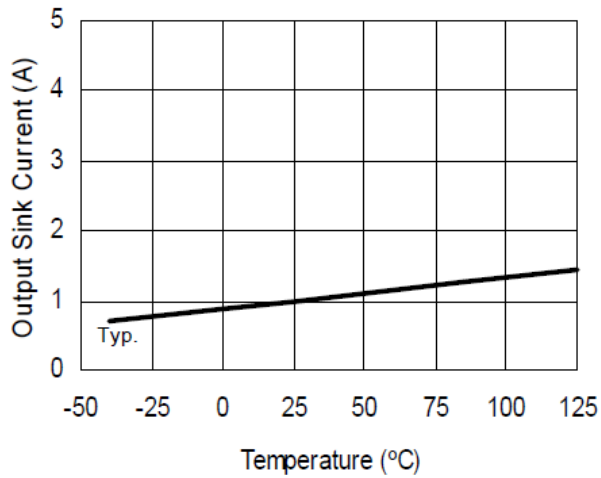
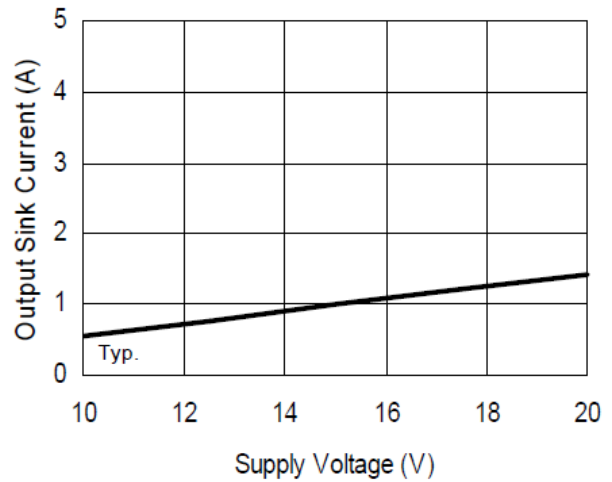


Figure 18. V_{CC} and V_{BS} Undervoltage Threshold (-) vs. Temperature


Figure 19A. Output Source Current vs. Temperature

Figure 19B. Output Source Current vs. Supply Voltage

Figure 20A. Output Sink Current vs. Temperature

Figure 20B. Output Sink Current vs. Supply Voltage

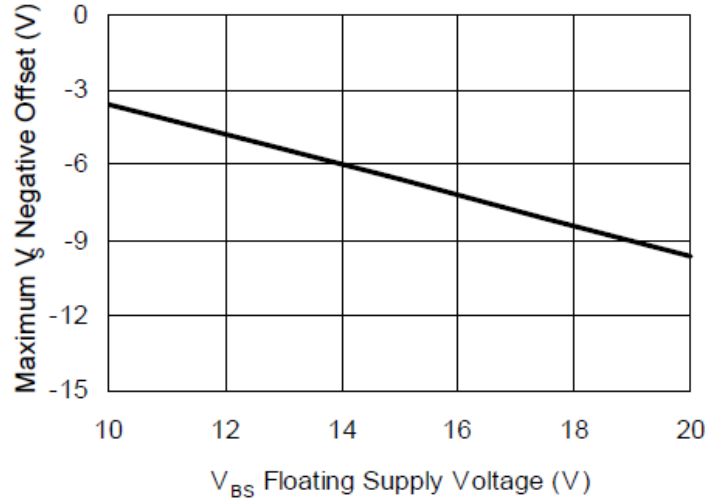


Figure 21. Maximum V_S Negative Offset vs. V_{BS} Floating Supply Voltage

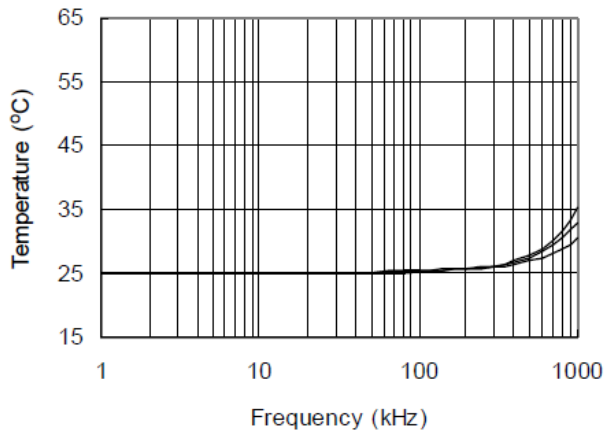


Figure 22. IRS2011S vs. Frequency (IRFBC20)
 $R_{gate} = 33\Omega, V_{CC} = 12V$

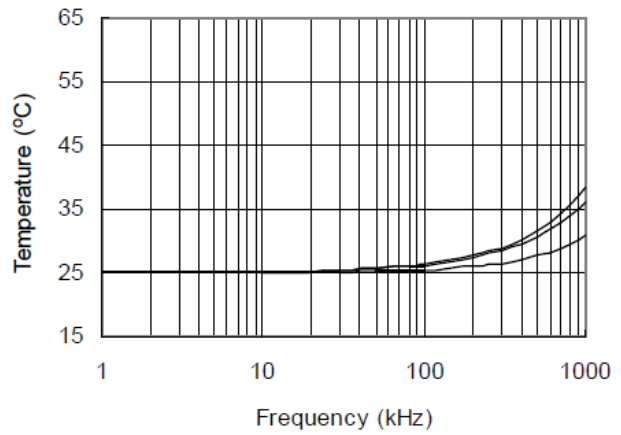


Figure 23. IRS2011S vs. Frequency (IRFB30)
 $R_{gate} = 22\Omega, V_{CC} = 12V$

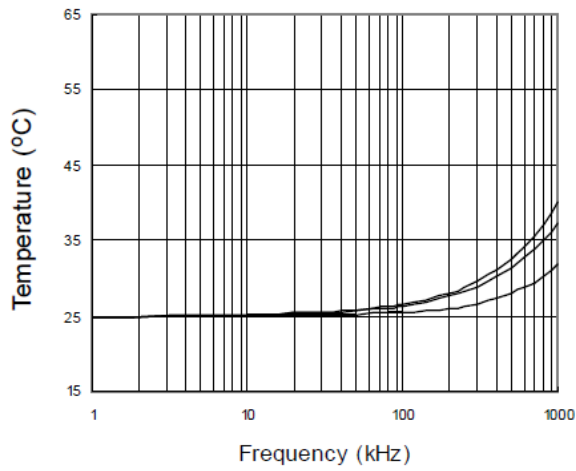


Figure 24. IRS2011S vs. Frequency (IRFBC40)
 $R_{gate} = 15\Omega, V_{CC} = 12V$

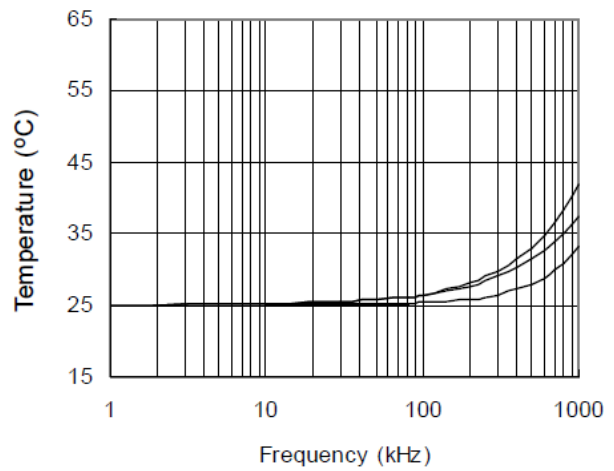


Figure 25. IRS2011S vs. Frequency (IRFB23N15D)
 $R_{gate} = 10\Omega, V_{CC} = 12V$

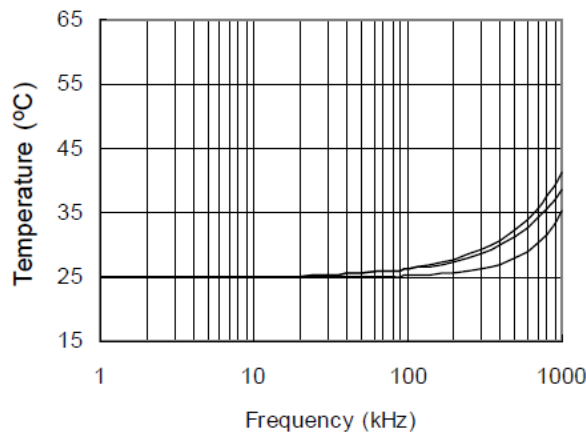
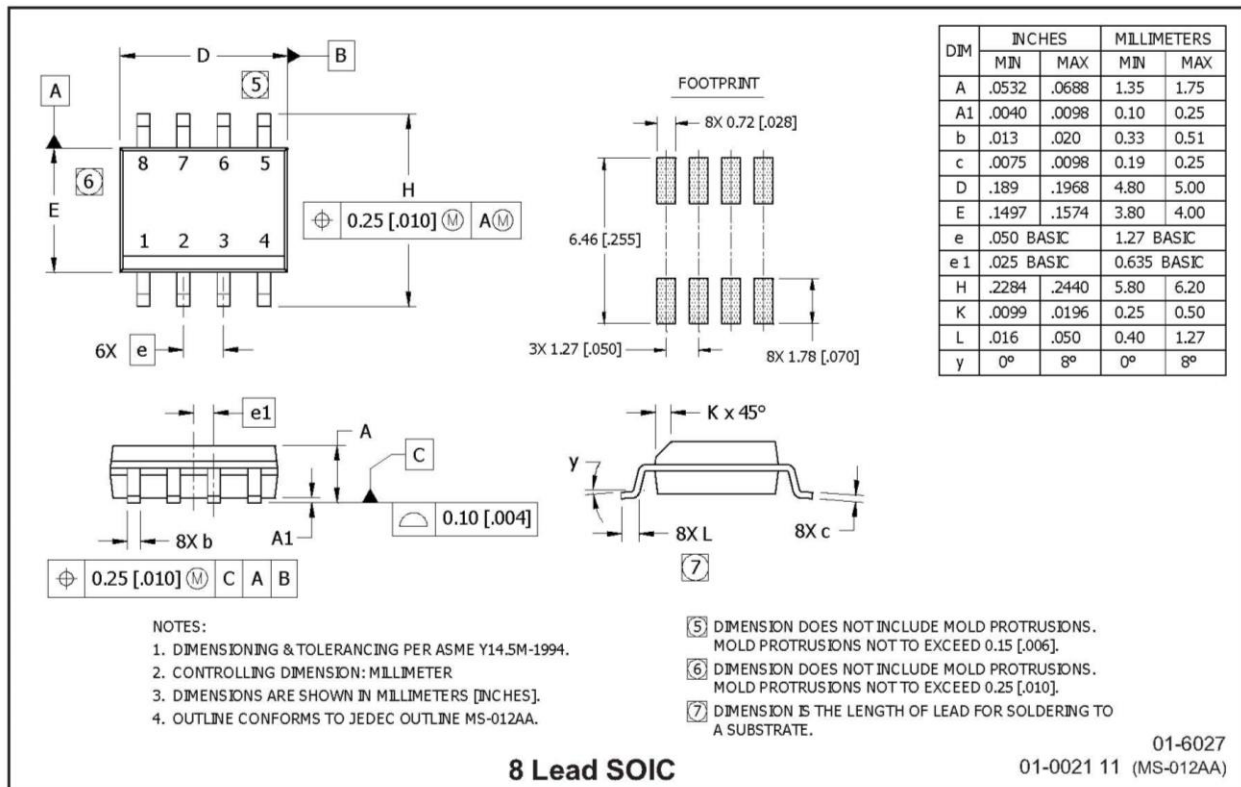
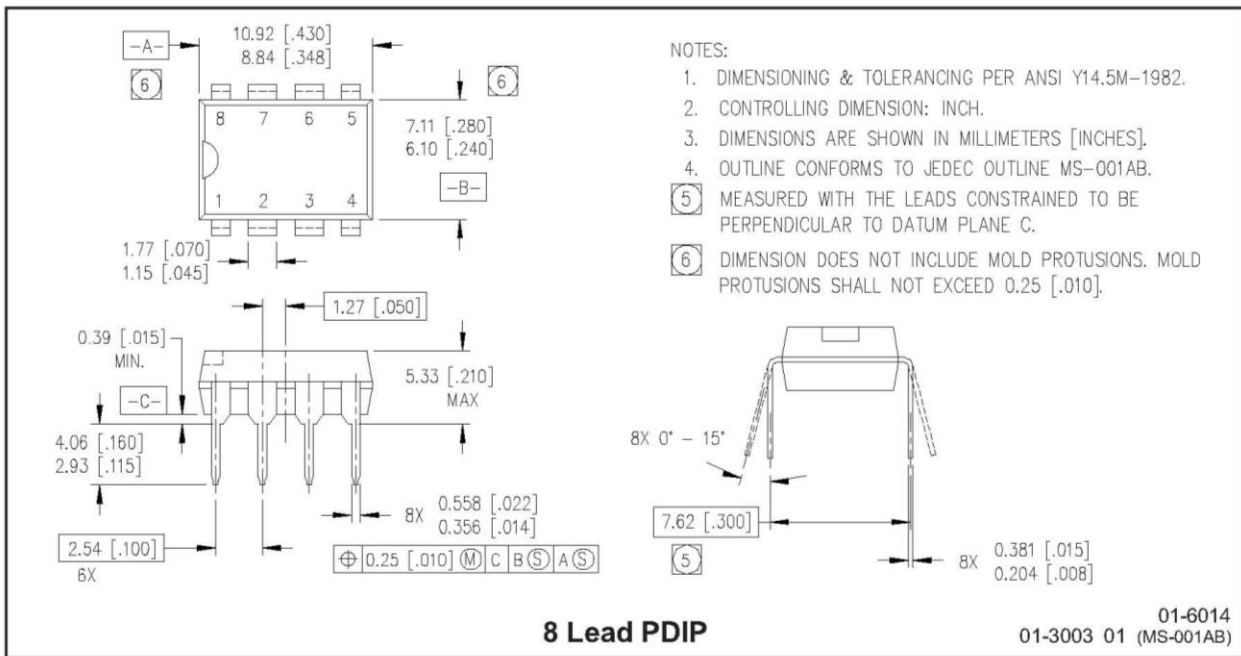
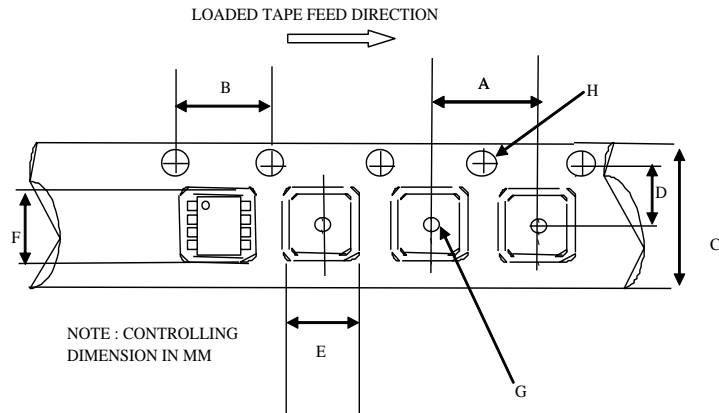


Figure 26. IRS2011S vs. Frequency (IRFB4212)
 $R_{gate} = 10\Omega, V_{CC} = 12V$

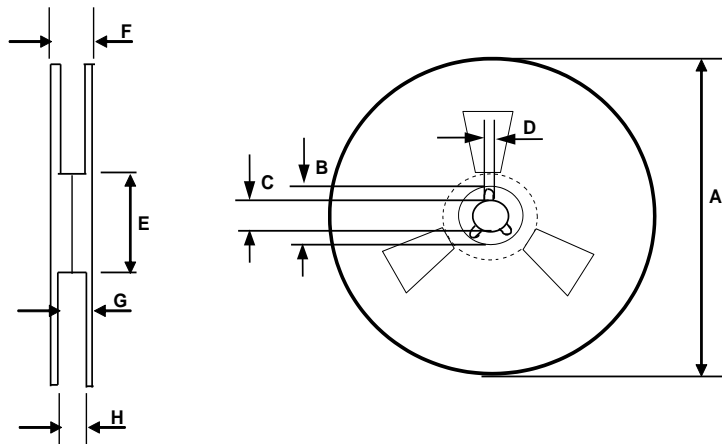
Package Details


Tape and Reel Details



CARRIER TAPE DIMENSION FOR 8SOICN

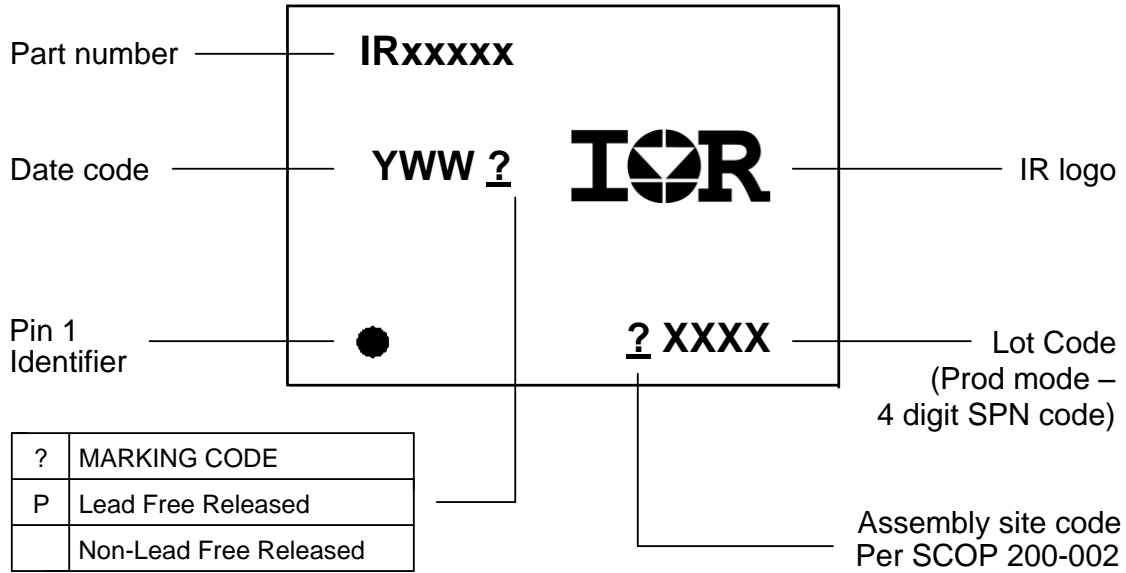
Code	Metric		Imperial	
	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	11.70	12.30	0.46	0.484
D	5.45	5.55	0.214	0.218
E	6.30	6.50	0.248	0.255
F	5.10	5.30	0.200	0.208
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062



REEL DIMENSIONS FOR 8SOICN

Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
H	12.40	14.40	0.488	0.566

Part Marking Information



Qualification Information[†]

Qualification Level		Industrial ^{††} (per JEDEC JESD 47)
		Comments: This family of ICs has passed JEDEC's Industrial qualification. IR's Consumer qualification level is granted by extension of the higher Industrial level.
Moisture Sensitivity Level	8-Lead SOIC	MSL2 ^{†††} (per IPC/JEDEC J-STD-020)
RoHS Compliant		Yes

† Qualification standards can be found at International Rectifier's web site <http://www.irf.com/>

†† Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.

††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

The information provided in this document is believed to be accurate and reliable. However, International Rectifier assumes no responsibility for the consequences of the use of this information. International Rectifier assumes no responsibility for any infringement of patents or of other rights of third parties which may result from the use of this information. No license is granted by implication or otherwise under any patent or patent rights of International Rectifier. The specifications mentioned in this document are subject to change without notice. This document supersedes and replaces all information previously supplied.

For technical support, please contact IR's Technical Assistance Center
<http://www.irf.com/technical-info/>

WORLD HEADQUARTERS:
 233 Kansas St., El Segundo, California 90245
 Tel: (310) 252-7105